

May 2001

FQT5N20

200V N-Channel MOSFET

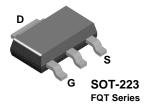
General Description

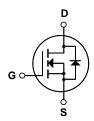
These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters, switch mode power supply, DC-AC converters for uninterrupted power supply, motor control.

Features

- 1.0A, 200V, $R_{DS(on)}$ = 1.2 Ω @V_{GS} = 10 V Low gate charge (typical 6.0 nC)
- Low Crss (typical 6.0 pF)
- Fast switching
- · Improved dv/dt capability





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQT5N20	Units
V _{DSS}	Drain-Source Voltage		200	V
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		1.0	А
	- Continuous (T _C = 70°	°C)	0.8	А
I _{DM}	Drain Current - Pulsed	(Note 1)	4.0	Α
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	60	mJ
I _{AR}	Avalanche Current	(Note 1)	1.0	Α
E _{AR}	Repetitive Avalanche Energy	(Note 1)	0.25	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	5.5	V/ns
P_D	Power Dissipation (T _C = 25°C) - Derate above 25°C		2.5	W
			0.02	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C
_				_

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		50	°C/W

^{*} When mounted on the minimum pad size recommended (PCB Mount)

200 	0.2		V
	0.2		V
			V/°C
		1	μА
		10	μΑ
		100	nA
		-100	nA
3.0		5.0	V
	0.96	1.2	Ω
	1.4		S
	40 6	50 8	pF pF
	6	8	pF
	7	25	ns
	55	120	ns
	9	30	ns
)	25	60	ns
	6.0	7.5	nC
	1.5		nC
,	2.2		nC
	1	1.0	Α.
			A
			V
	95	1.5	-
			ns
	 	0.96 1.4 210 40 6 55 9 25 6.0 1.5 2.2	0.96 1.2 1.4 210 270 40 50 6 8 7 25 55 120 9 30 25 60 6.0 7.5 1.5 2.2 1.0 4.0

- **Notes:**1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 90mH, I_{AS} = 1.0A, V_{DD} = 50V, R_G = 25 Ω, Starting T_J = 25°C 3. I_{SD} ≤ 4.5A, di/dt ≤ 300A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C 4. Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2% 5. Essentially independent of operating temperature

Typical Characteristics

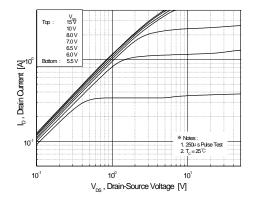


Figure 1. On-Region Characteristics

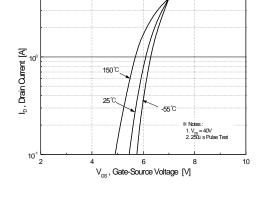


Figure 2. Transfer Characteristics

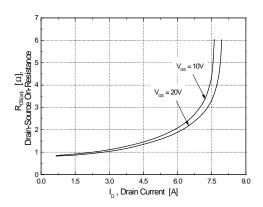


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

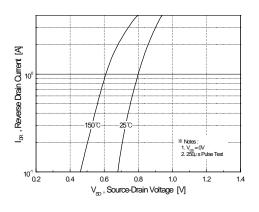


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

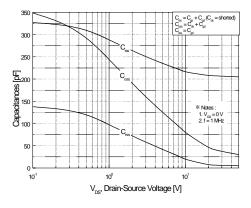


Figure 5. Capacitance Characteristics

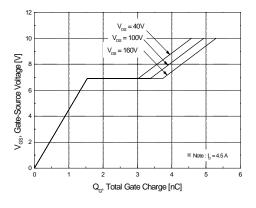


Figure 6. Gate Charge Characteristics

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Typical Characteristics (Continued)

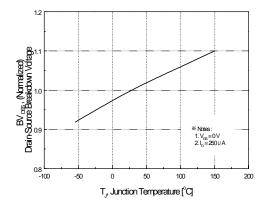


Figure 7. Breakdown Voltage Variation vs. Temperature

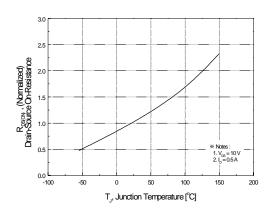


Figure 8. On-Resistance Variation vs. Temperature

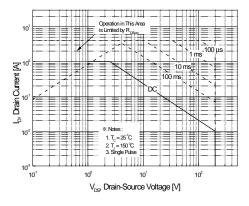


Figure 9. Maximum Safe Operating Area

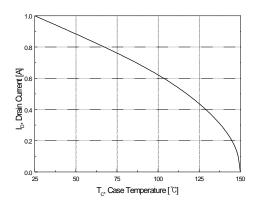


Figure 10. Maximum Drain Current vs. Case Temperature

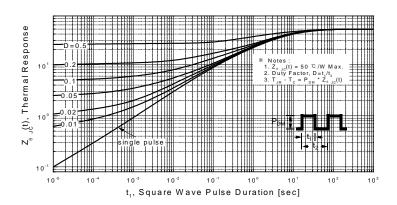
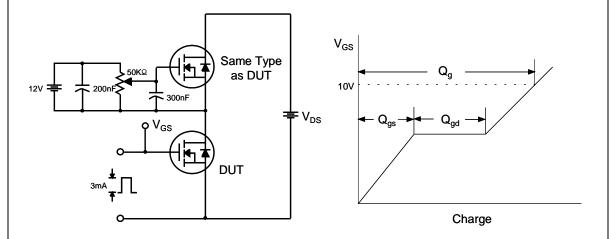


Figure 11. Transient Thermal Response Curve

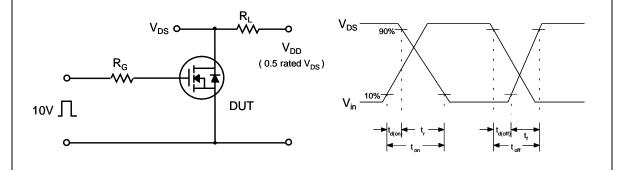
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(Note 4)
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(Note 4)

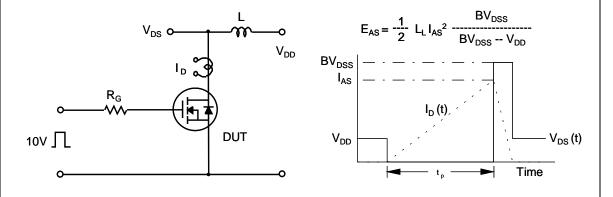
Gate Charge Test Circuit & Waveform



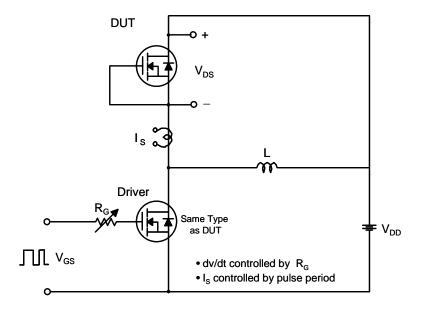
Resistive Switching Test Circuit & Waveforms

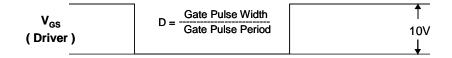


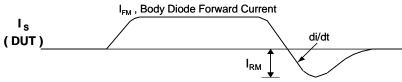
Unclamped Inductive Switching Test Circuit & Waveforms



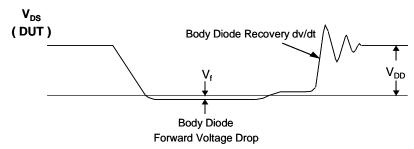
Peak Diode Recovery dv/dt Test Circuit & Waveforms





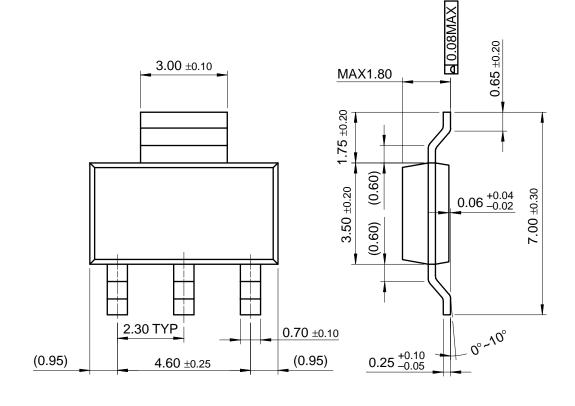


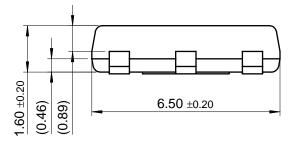
Body Diode Reverse Current



Package Dimensions

SOT-223





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